

**• General Description**

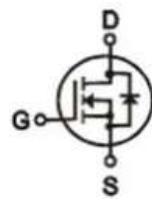
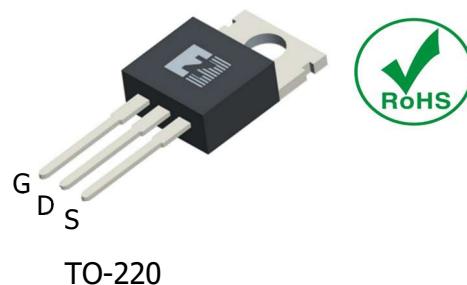
The ZM098N06HP combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ . This device is ideal for load switch and battery protection applications.

**• Features**

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

**• Application**

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

**• Product Summary** $V_{DS} = 60V$  $R_{DS(ON)} = 11m\Omega$  $I_D = 55A$ **• Ordering Information:**

Part NO.	ZM098N06HP
Marking	ZM098N06H
Packing Information	Bulk Tube
Basic ordering unit (pcs)	1000

**• Absolute Maximum Ratings ( $T_c = 25^\circ C$ )**

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D @ T_c = 25^\circ C$	55	A
	$I_D @ T_c = 75^\circ C$	42	A
	$I_D @ T_c = 100^\circ C$	35	A
Pulsed Drain Current <sup>①</sup>	$I_{DM}$	104	A
Total Power Dissipation( $T_c = 25^\circ C$ )	$P_D @ T_c = 25^\circ C$	120	W
Total Power Dissipation( $T_A = 25^\circ C$ )	$P_D @ T_A = 25^\circ C$	5	W
Operating Junction Temperature	$T_J$	-55 to 150	$^\circ C$
Storage Temperature	$T_{STG}$	-55 to 150	$^\circ C$
Single Pulse Avalanche Energy@ $L=0.1mH$	$E_{AS}$	80	mJ



Avalanche Current@L=0.1mH	I <sub>AS</sub>	40	A
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## •Thermal resistance

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	1	° C/W
Thermal resistance, junction - ambient	R <sub>thJA</sub>	-	-	25	° C/W
Soldering temperature, wavesoldering for 10s	T <sub>sold</sub>	-	-	265	° C

## •Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	60			V
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	2.0		4.0	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V			1.0	uA
Gate- Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V ,V <sub>DS</sub> =0V			±100	nA
Static Drain-source On Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =24A		11	14.5	mΩ
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =25V, I <sub>D</sub> =10A		30		s
Source-drain voltage	V <sub>SD</sub>	I <sub>S</sub> =24A			1.28	V

## •Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V f = 1MHz	-	3350	-	pF
Output capacitance	C <sub>oss</sub>		-	155	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	135	-	

## Gate Charge characteristics(Ta= 25°C)

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Total gate charge	Q <sub>g</sub>	V <sub>DD</sub> =25V I <sub>D</sub> = 8A V <sub>GS</sub> = 10V	-	30	-	nC
Gate - Source charge	Q <sub>gs</sub>		-	9	-	
Gate - Drain charge	Q <sub>gd</sub>		-	15	-	

Note: ① Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2% ;



Fig.1 SOA Maximum Safe Operating Area

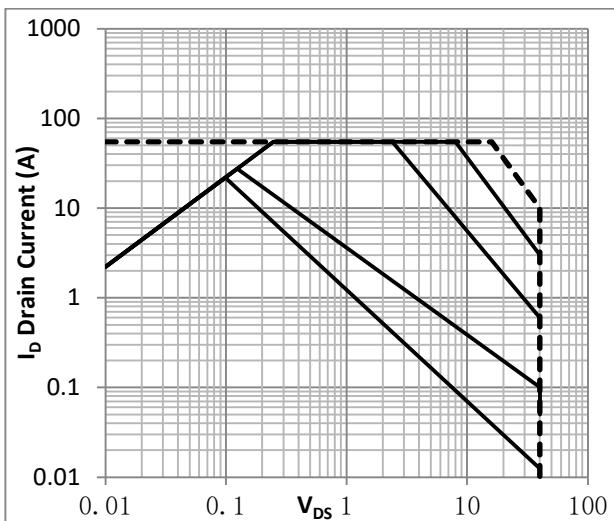


Fig.2 ID-Junction Temperature

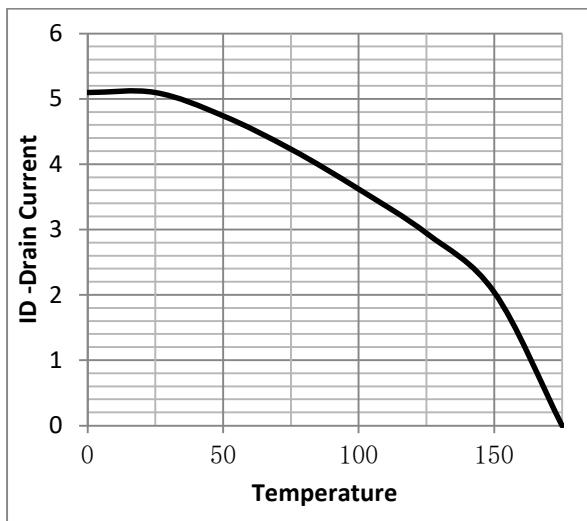


Fig.3 Gate-Charge Characteristics

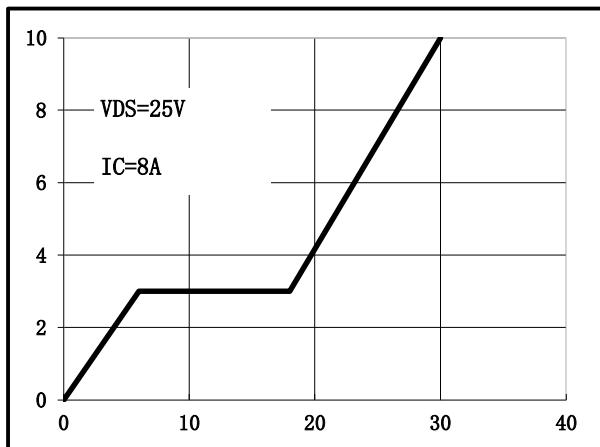


Fig.4 Capacitance Characteristics

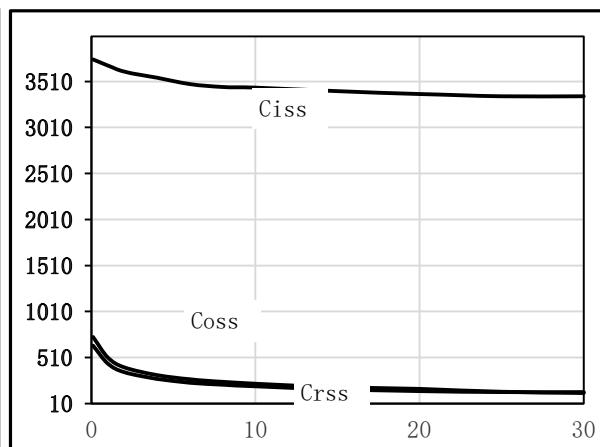


Fig.5 Power Dissipation

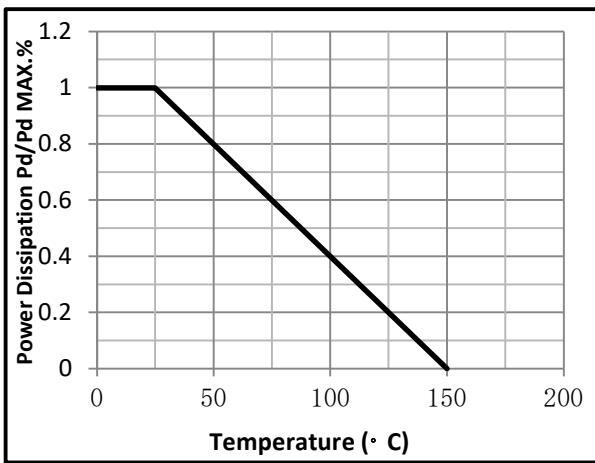


Fig.6 Typical output Characteristics

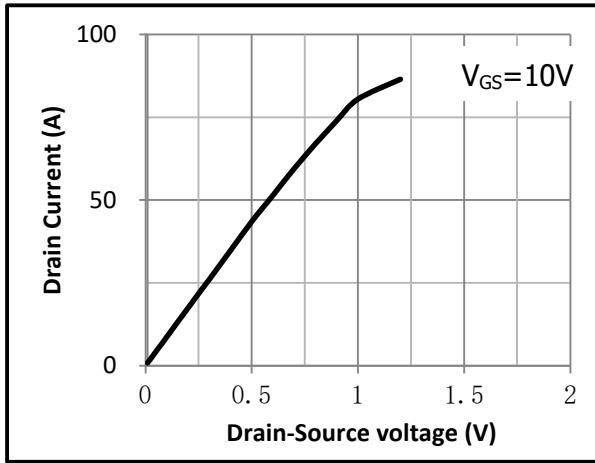




Fig.7 Threshold Voltage V.S Junction Temperature

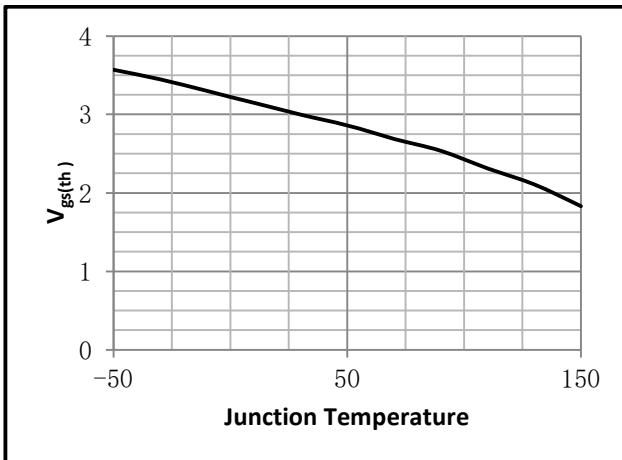


Fig.8 Resistance V.S Drain Current

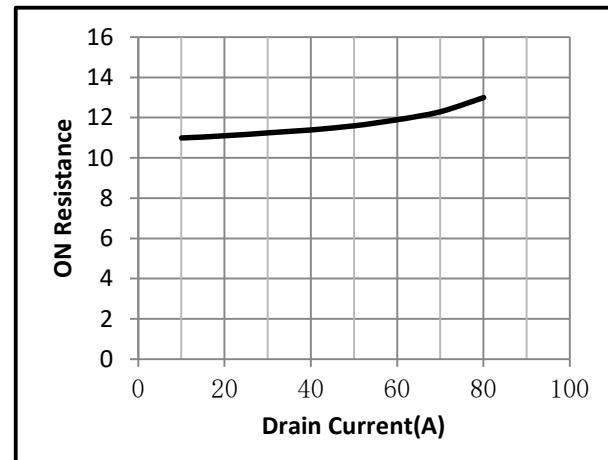


Fig.9 On-Resistance VS Gate Source Voltage

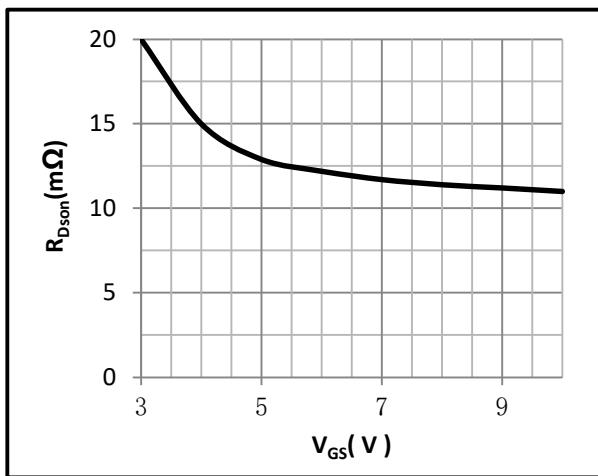


Fig.10 On-Resistance V.S Junction Temperature

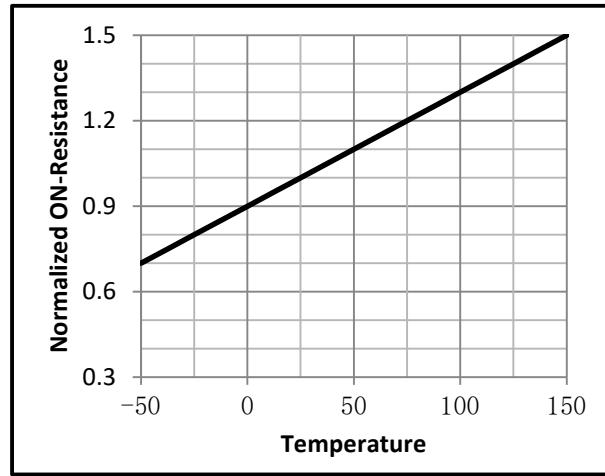


Fig.11 Switching Time Measurement Circuit

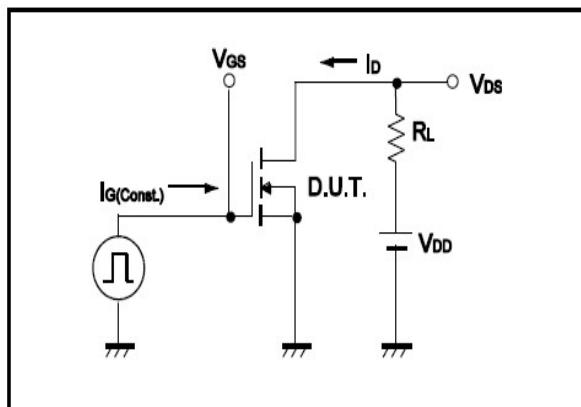


Fig.12 Gate Charge Waveform

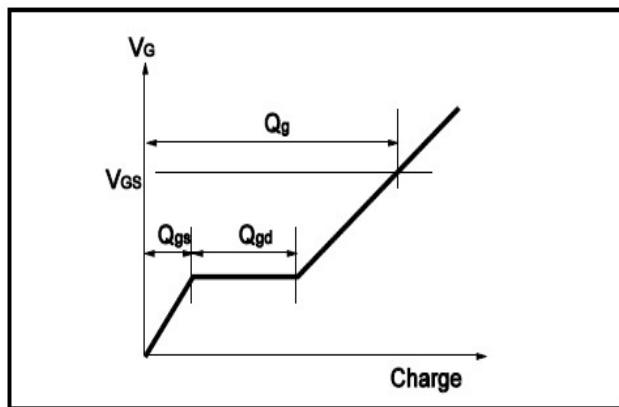


Fig.13 Switching Time Measurement Circuit

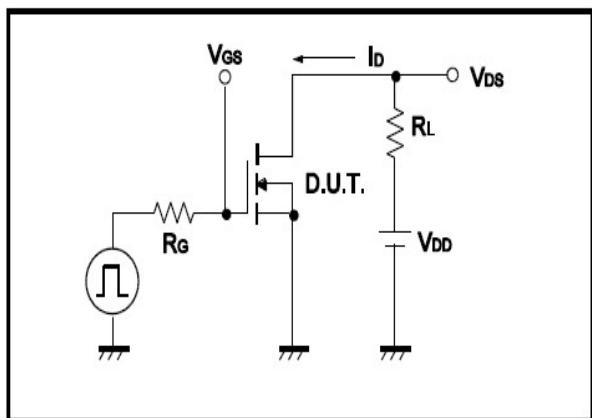


Fig.14 Gate Charge Waveform

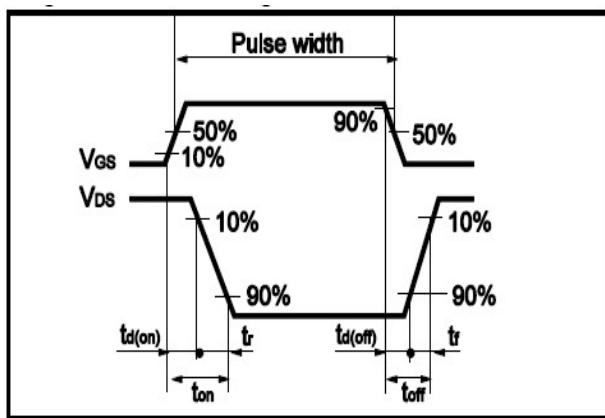


Fig.15 Avalanche Measurement Circuit

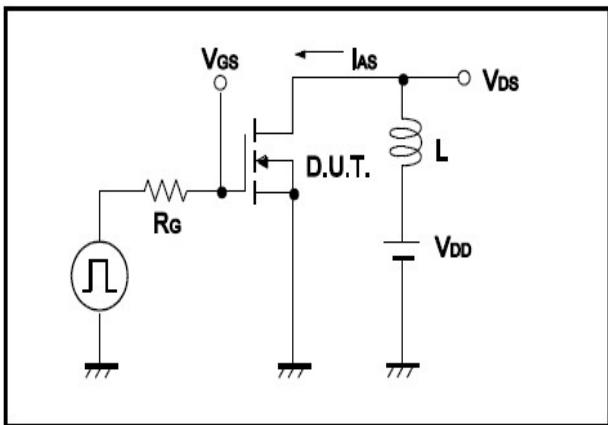


Fig.16 Avalanche Waveform

**• Dimensions (TO-220)**

Unit: mm

SYMBOL	min	nom	max	SYMBOL	min	nom	max
A	4.00		4.80	E	9.90		10.70
B	1.20		1.50	e		2.54	
B1	1.00		1.40	F	1.10		1.45
b1	0.65		1.00	L	12.50		14.50
c	0.35		0.75	L1	3.00	3.50	4.00
D	15.00		16.50	Q	2.50		3.00
D1	5.90		6.90	Q1	2.00		3.00
				ΦP	3.60		3.90

